

UNISONIC TECHNOLOGIES CO., LTD

UTM6006 Power MOSFET

6.3A, 60V N-CHANNEL FAST SWITCHING MOSFET

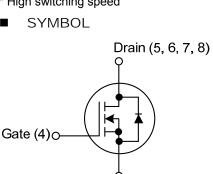
DESCRIPTION

The UTC UTM6006 is an N-Channel MOSFET, it uses UTC's advanced technology to provide customers with a minimum on-state resistance, high switching speed and low gate charge.

The UTC UTM6006 is suitable for application in networking DC-DC power system and LCD/LED back light, etc.

FEATURES

- * $R_{DS(ON)}$ < 18 m Ω @ V_{GS} =10V, I_D =6A $R_{DS(ON)}$ < 20 m Ω @ V_{GS} =4.5V, I_{D} =4A
- * Low gate charge
- * Excellent CdV/dt effect decline
- * High switching speed



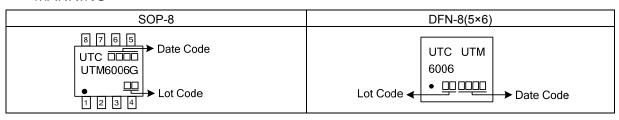
ORDERING INFORMATION

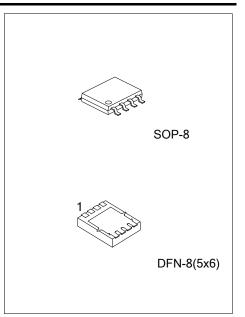
Source (1, 2, 3)

Ordering Number	Package	Pin Assignment							Dooking	
Ordering Number		1	2	3	4	5	6	7	8	Packing
UTM6006G-S08-R	SOP-8	S	S	S	G	D	D	D	D	Tape Reel
UTM6006G-K08-5060-R	DFN-8(5×6)	S	S	S	G	D	D	D	D	Tape Reel
Note: Pin Assignment: G: Gate D: Drain	S: Source									

UTM6006G-S08-R (1)Packing Type (1) R: Tape Reel (2) S08: SOP-8, K08-5060: DFN-8(5×6) (2)Package Type (3)Green Package (3) G: Halogen Free and Lead Free

MARKING





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■ ABSOLUTE MAXIMUM RATINGS

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V _{DSS}	60	V	
Gate-Source Vo	oltage		V_{GSS}	V _{GSS} ±20	
	Continuous	T _A =25°C		6.3	Α
	V _{GS} @ 10V (Note 1)	T _A =70°C	I _D	5.0	Α
	Pulsed (Note 2)		I _{DM}	32	Α
Avalanche Curr	ent		I _{AS} 28		Α
Single Pulse Av	ingle Pulse Avalanche Energy (Note 3)		E _{AS}	67	mJ
Power Dissipation (T _A =25°C) (Note 4)		-	1.5	W	
Power Dissipation	on (1 _A =25 C) (Note 4)	DFN-8(5×6)	P_D	1.92	
Junction Tempe	rature		TJ	-55~+150	°C
Storage Temperature Range		T _{STG}	-55~+150	°C	

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ THERMAL CHARACTERISTICS (Note 1)

PARAMETE	R	SYMBOL	RATINGS	UNIT
Junction to Ambient	SOP-8	0	85	°C/M
	DFN-8(5×6)	θ_{JA}	65	°C/W
lunation to Coop	SOP-8	0	24	°C // //
Junction to Case	DFN-8(5×6)	the state of the s	°C/W	

Notes: 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

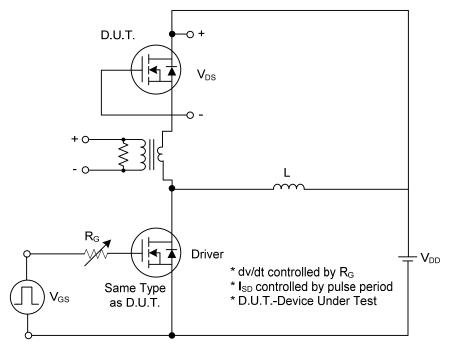
- 2. The data tested by pulsed, pulse width \leq 300 μ s, duty cycle \leq 2%.
- 3. The EAS data shows Max. rating. The test condition is V_{DD} =25V, V_{GS} =10V, L=0.1mH, I_{AS} =30A.
- 4. The power dissipation is limited by 150°C junction temperature.

■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise noted)

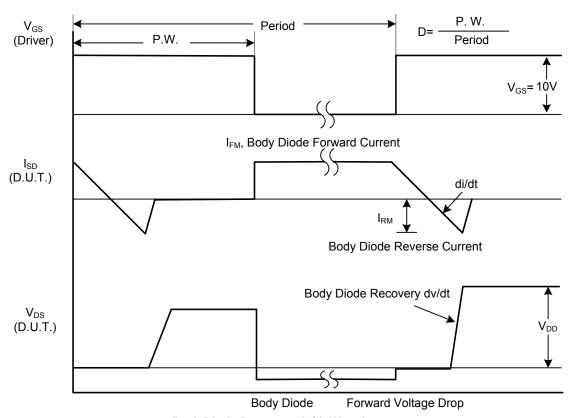
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	I _D =250μA, V _{GS} =0V	60			V
BV _{DSS} Temperature Coefficient		$\triangle BV_{DSS}/\triangle T_{J}$	Reference to 25°C , I _D =1mA		0.057		V/°C
Drain-Source Leakage Current		I _{DSS}	V _{DS} =48V, V _{GS} =0V, T _J =25°C			1	μA
			V _{DS} =48V, V _{GS} =0V, T _J =55°C			5	μA
Gate-Source Leakage Current	Forward	- I _{GSS}	V _{GS} =+20V, V _{DS} =0V			+100	nA
	Reverse		V _{GS} =-20V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$		1.2		2.5	V
			V _{DS} =V _{GS} , I _D =250μA		5.00		mV/°
V _{GS(TH)} Temperature Coefficient		$\triangle V_{GS(TH)}$			-5.68		С
Static Drain-Source On-State Resistance		В	V_{GS} =10V, I_D =6A		14	18	mΩ
(Note 2)		R _{DS(ON)}	V_{GS} =4.5 V , I_D =4 A		16	20	mΩ
Forward Transconductance		g FS	V_{DS} =5V, I_D =6A		40		S
DYNAMIC PARAMETERS							
Input Capacitance	nput Capacitance				1070	1200	pF
Output Capacitance Reverse Transfer Capacitance		C _{ISS}	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		200	220	pF
		C _{RSS}			190	210	pF
SWITCHING PARAMETERS (N	ote 2)			_			_
Total Gate Charge (4.5V) Gate to Source Charge Gate to Drain Charge		Q_G			290	310	nC
		Q_{GS}	V _{GS} =10V, V _{DS} =48V, I _D =1A		10.7	15	nC
		Q_{GD}			30	45	nC
Turn-ON Delay Time					55	70	ns
Rise Time		t _R	V_{GS} =10V, V_{DD} =30V,		100	120	ns
Turn-OFF Delay Time		t _{D(OFF)}	$R_G=3.3\Omega$, $I_D=2A$		580	620	ns
Fall-Time					190	210	ns
GUARANTEED AVALANCHE	CHARACT	ERISTICS			-		
Single Pulse Avalanche Energy (Note 5)		E _{AS}	V _{DD} =25V, L=0.1mH, I _{AS} =15A	19			mJ
DIODE CHARACTERISTICS							_
Continuous Source Current (Note 1, 6) Pulsed Source Current (Note 2, 6)		I _S	V =V =0V Force Current			6.3	Α
		I _{SM}	V _G =V _D =0V , Force Current			32	Α
Diode Forward Voltage (Note 2)		V_{SD}	V _{GS} =0V , I _S =6.3A , T _J =25°C			1	V
Reverse Recovery Time	9 \				15		nS
Reverse Recovery Charge		t _{rr} Q _{rr}	I _F =6A, dI/dt=100A/μs, T _J =25°C		10.4		nC
National The data to total by surface required on a 4 inch ² ED 4 heard with 207 corner							

- Notes: 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
 - 2. The data tested by pulsed, pulse width≤300µs, duty cycle≤2%.
 - 3. The EAS data shows Max. rating. The test condition is V_{DD} =25V, V_{GS} =10V, L=0.1mH, I_{AS} =30A.
 - 4. The power dissipation is limited by 150°C junction temperature.
 - 5. The Min. value is 100% EAS tested guarantee.
 - 6. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

■ TEST CIRCUITS AND WAVEFORMS

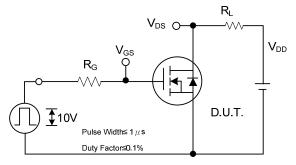


Peak Diode Recovery dv/dt Test Circuit

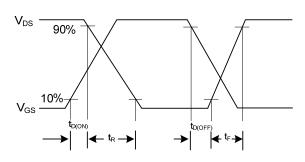


Peak Diode Recovery dv/dt Waveforms

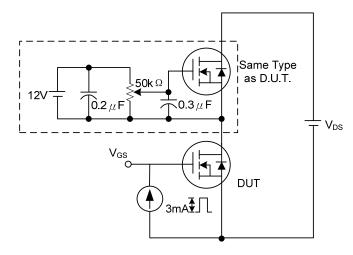
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



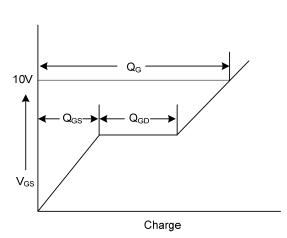
Switching Test Circuit



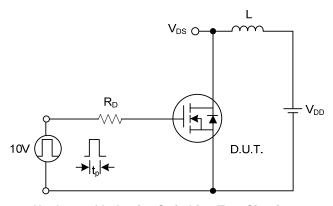
Switching Waveforms



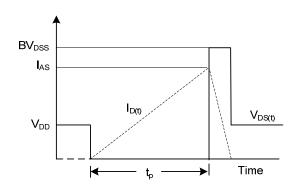
Gate Charge Test Circuit



Gate Charge Waveform

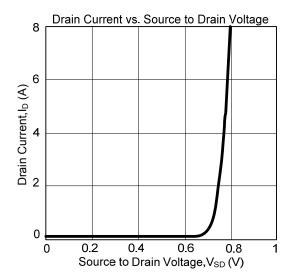


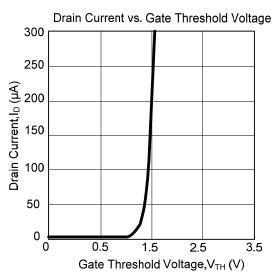
Unclamped Inductive Switching Test Circuit

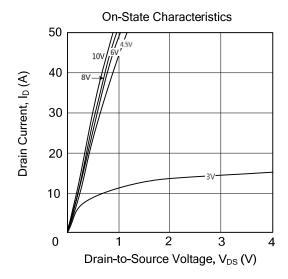


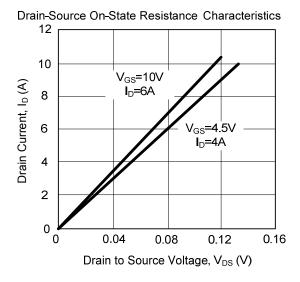
Unclamped Inductive Switching Waveforms

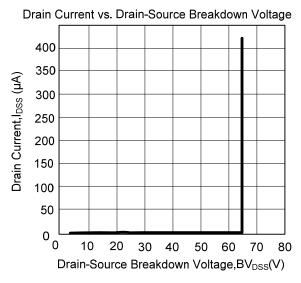
■ TYPICAL CHARACTERISTICS

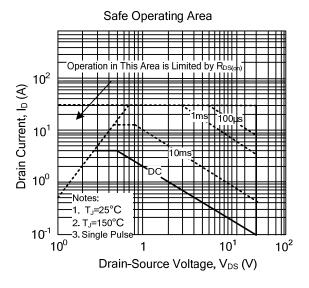




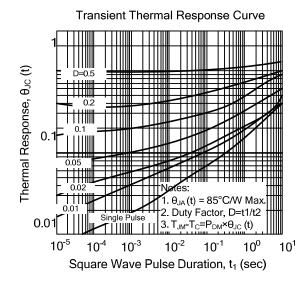


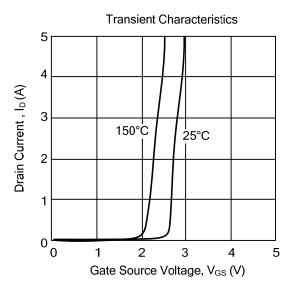






■ TYPICAL CHARACTERISTICS (Cont.)





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